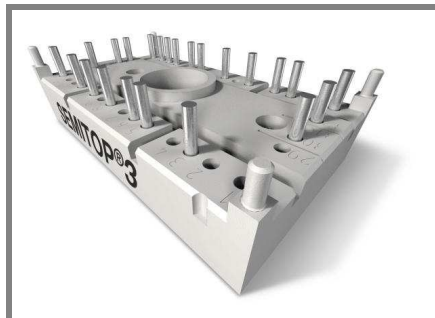


# SK 40 DT



SEMITOP® 3

## Controllable Bridge Rectifier

### SK 40 DT

Preliminary Data

### Features

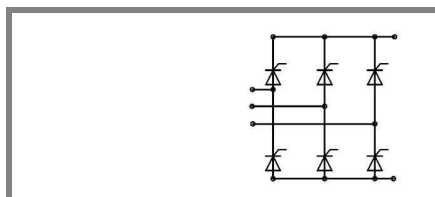
- Compact design
- One screw mounting
- Heat transfer and insulation through direct copper bonded aluminium oxide ceramic (DBC)
- Glass passivated thyristor chips
- Up to 1600V reverse voltage
- UL recognized, file no. E 63 532

### Typical Applications\*

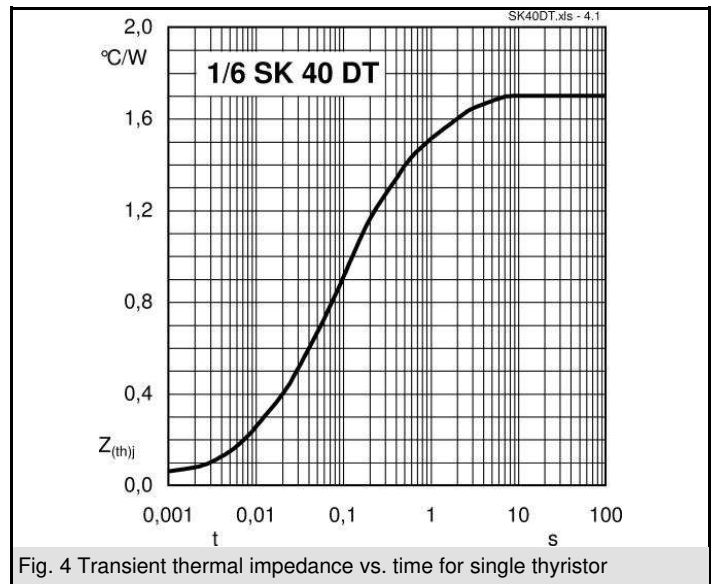
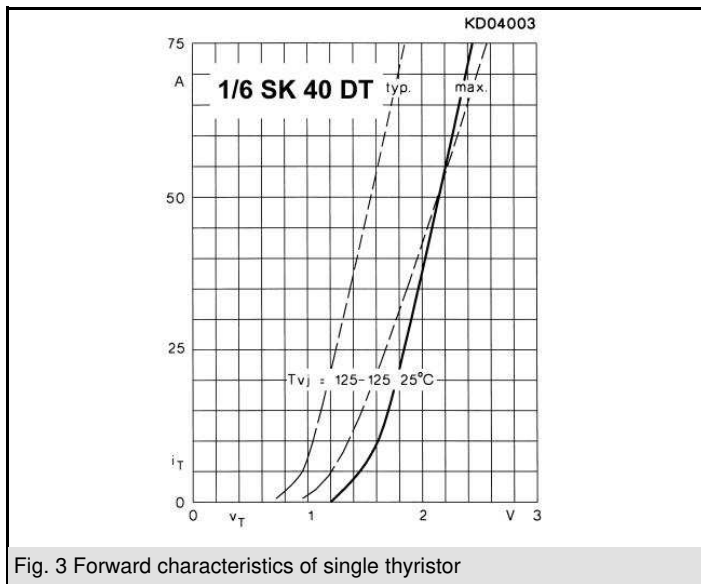
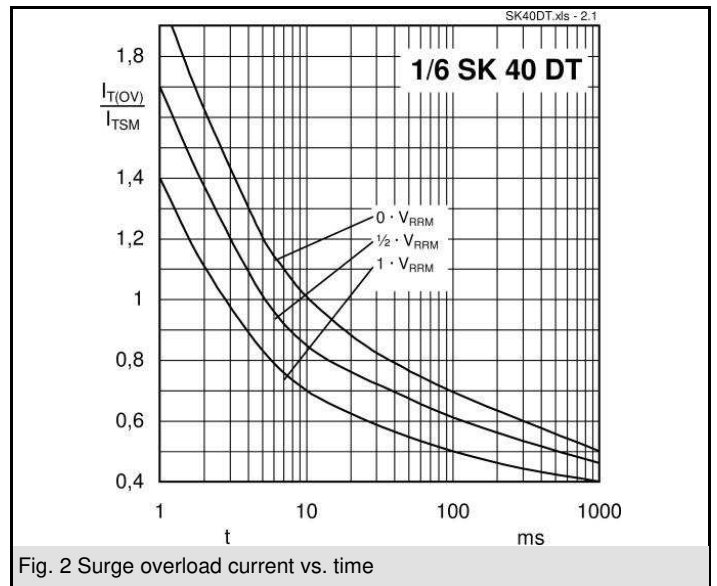
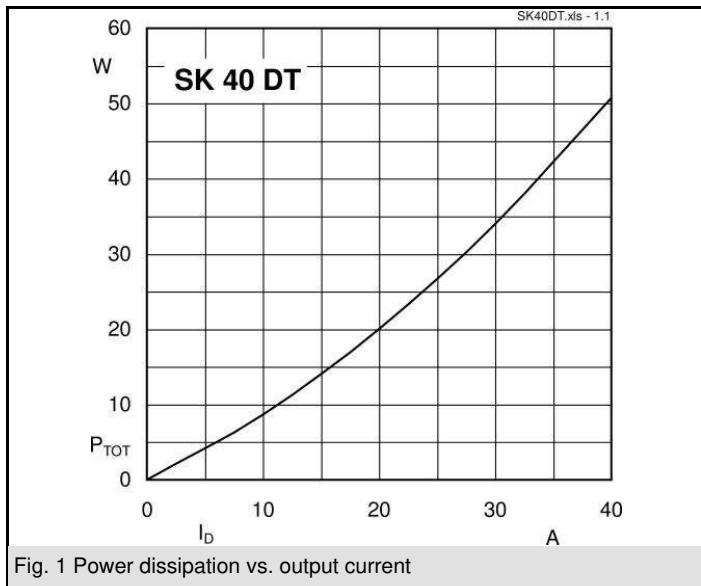
- Soft starters
- Light control
- Temperature control
- Motor control

$V_{RSM}$ V	$V_{RRM}, V_{DRM}$ V	$I_D = 42$ A (full conduction) ( $T_s = 80$ °C)
900	800	SK 40 DT 08
1300	1200	SK 40 DT 12
1700	1600	SK 40 DT 16

Symbol	Conditions	Values	Units
$I_D$	$T_s = 80$ °C	42	A
$I_{FSM}$	$T_{vj} = 25$ °C; 10 ms $T_{vj} = 125$ °C; 10 ms	320 280	A A
$i^2t$	$T_{vj} = 25$ °C; 8,3 ... 10 ms $T_{vj} = 125$ °C; 8,3...10 ms	510 390	A <sup>2</sup> s A <sup>2</sup> s
$V_T$	$T_{vj} = 25$ °C; 75A	max. 2,45	V
$V_{T(TO)}$	$T_{vj} = 125$ °C;	max. 1,1	V
$r_T$	$T_{vj} = 125$ °C	max. 20	mΩ
$I_{DD}, I_{RD}$	$T_{vj} = 125$ °C; $V_{DD} = V_{DRM}; V_{RD} = V_{RRM}$	max. 8	mA
$t_{gd}$	$T_{vj} =$ °C; $I_G =$ A; $di_G/dt =$ A/μs		μs
$t_{gr}$	$V_D = \cdot V_{DRM}$		μs
$(dv/dt)_{cr}$	$T_{vj} = 125$ °C	max. 1000	V/μs
$(di/dt)_{cr}$	$T_{vj} = 125$ °C; $f = 50..60$ Hz	max. 100	A/μs
$t_q$	$T_{vj} = 125$ °C; typ.	80	μs
$I_H$	$T_{vj} = 25$ °C; typ. / max.	80 / 150	mA
$I_L$	$T_{vj} = 25$ °C; $R_G = 33$ Ω	150 / 300	mA
$V_{GT}$	$T_{vj} = 25$ °C; d.c.	min. 2	V
$I_{GT}$	$T_{vj} = 25$ °C; d.c.	min. 100	mA
$V_{GD}$	$T_{vj} = 125$ °C; d.c.	max. 0,25	V
$I_{GD}$	$T_{vj} = 125$ °C; d.c.	max. 3	mA
$R_{th(j-s)}$	Per thyristor	1,7	K/W
$T_{solder}$	Terminals, 10s	260	K/W °C
$T_{vj}$		-40...+125	°C
$T_{stg}$		-40...+125	°C
$V_{isol}$	a. c. 50 Hz; r.m.s.; 1 s / 1 min.	3000 ( 2500 )	V
$M_s$	Mounting torque to heatsink	2,5	Nm
m	weight	30	g
Case	SEMITOP® 3	T 15	



DT



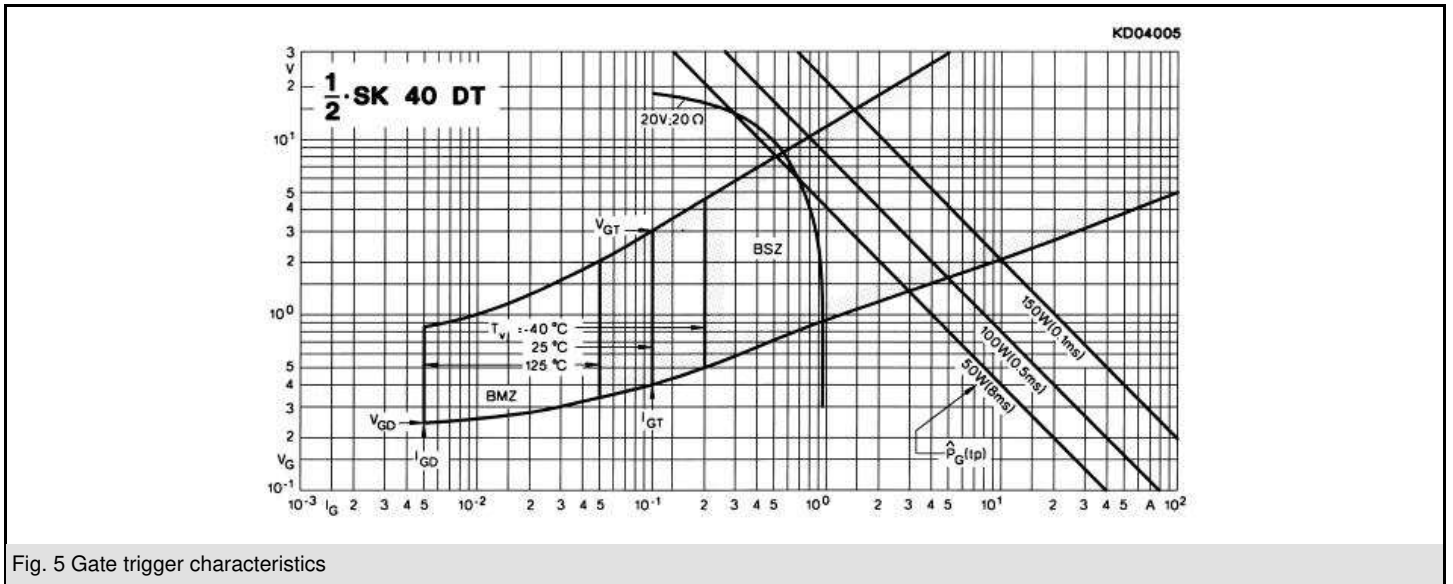
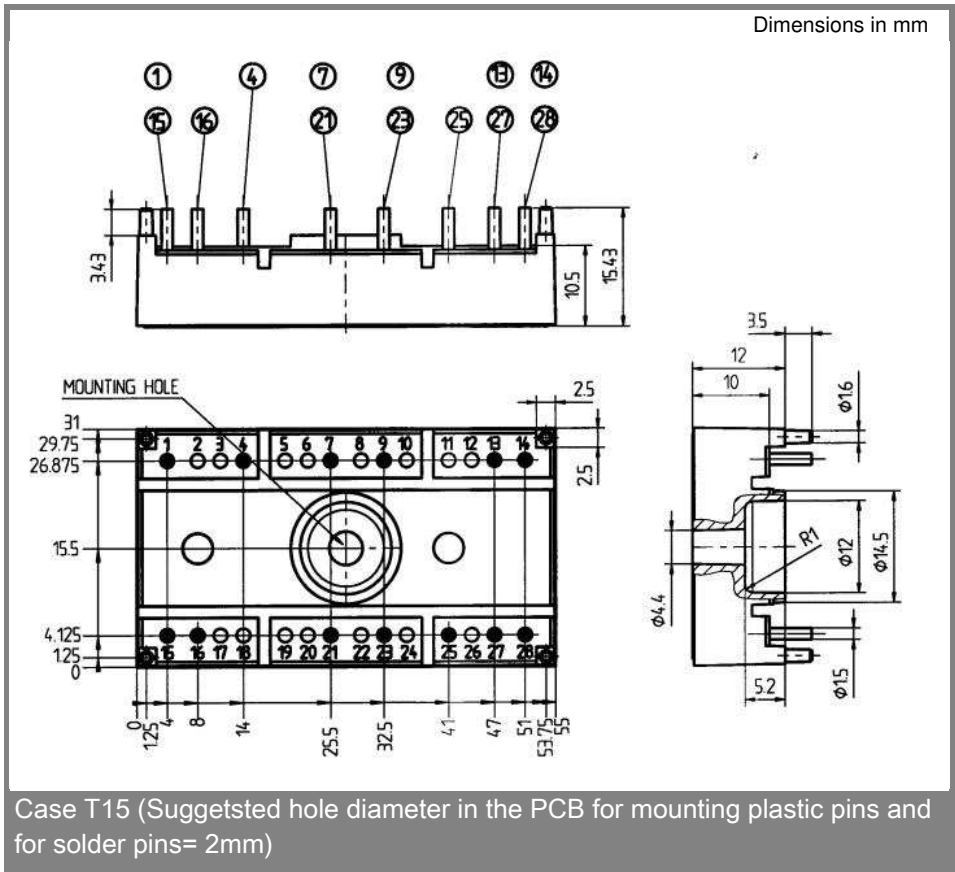
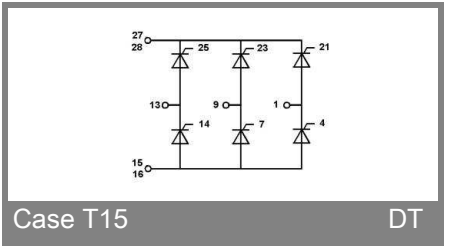


Fig. 5 Gate trigger characteristics



Case T15 (Suggested hole diameter in the PCB for mounting plastic pins and for solder pins= 2mm)



Case T15 DT

\* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.